

BGY68

75 MHz, 30 dB gain reverse amplifier

Rev. 5 — 28 September 2010 Product data sheet

1. Product profile

1.1 General description

Hybrid high dynamic range amplifier module in a SOT115J package operating at a voltage supply of 24 V (DC).

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Excellent linearity
- Extremely low noise
- Silicon nitride passivation
- Rugged construction
- Gold metallization ensures excellent reliability

1.3 Applications

- Reverse amplifier in two-way CATV systems in the 5 MHz to 75 MHz frequency range

1.4 Quick reference data

Table 1. Quick reference data

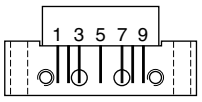
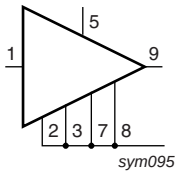
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	f = 10 MHz	29.2	-	30.8	dB
I_{tot}	total current consumption (DC)	[1]	-	-	135	mA

[1] The module normally operates at V_B = 24 V, but is able to withstand supply transients up to 30 V.

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2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	input		
2	common		
3	common		
5	$+V_B$		
7	common		
8	common		
9	output		

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BGY68	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 × 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_i	RF input voltage		-	55	dBmV
T_{stg}	storage temperature		−40	+100	°C
T_{mb}	mounting base temperature		−20	+100	°C

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5. Characteristics

Table 5. Characteristics

Bandwidth 5 MHz to 75 MHz; V_B = 24 V; T_{mb} = 30 °C; Z_S = Z_L = 75 Ω; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
G_p	power gain	f = 10 MHz		29.2	-	30.8	dB
SL	slope cable equivalent	f = 5 MHz to 75 MHz		−0.2	-	+0.5	dB
FL	flatness of frequency response	f = 5 MHz to 75 MHz		-	-	±0.2	dB
s_{11}	input return losses	f = 5 MHz to 75 MHz		20	-	-	dB
s_{22}	output return losses	f = 5 MHz to 50 MHz		20	-	-	dB
		f = 50 MHz to 75 MHz		18	-	-	dB
CTB	composite triple beat	4 channels flat; V_o = 50 dBmV; measured at 25 MHz		-	-	−68	dB
X_{mod}	cross modulation	4 channels flat; V_o = 50 dBmV; measured at 25 MHz		-	-	−60	dB
d_2	second order distortion		[1]	-	-	−70	dB
F	noise figure	f = 75 MHz		-	-	3.5	dB
I_{tot}	total current consumption (DC)		[2]	-	-	135	mA

[1] f_p = 19 MHz; V_p = 50 dBmV; f_q = 31 MHz; V_q = 50 dBmV; measured at $f_p + f_q$ = 50 MHz.

[2] The module normally operates at V_B = 24 V, but is able to withstand supply transients up to 30 V.

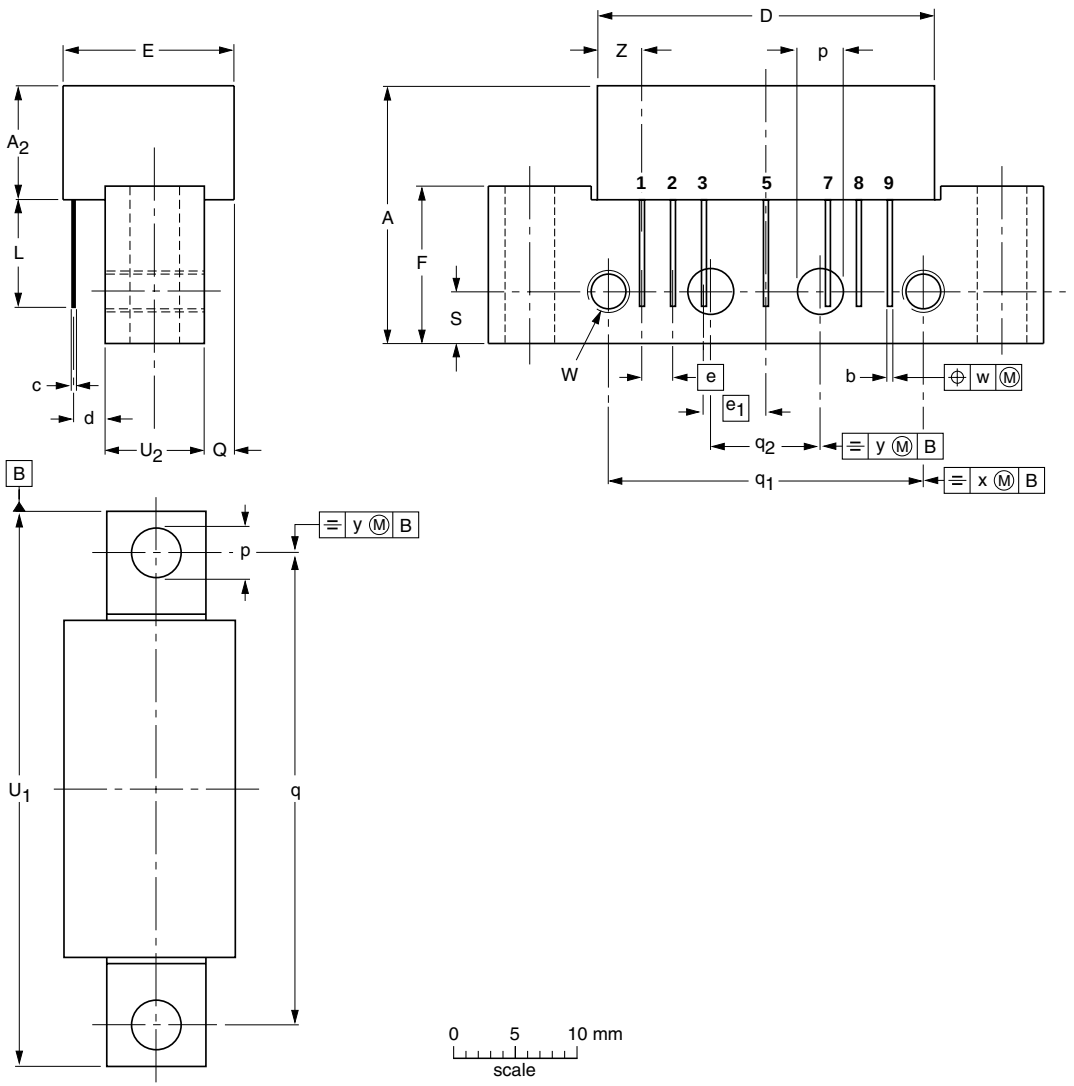
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6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads **SOT115J**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_2 max.	b	c	D max.	d	E max.	e	e_1	F	L min.	p	Q max.	q	q_1	q_2	S	U_1	U_2	W	w	x	y	Z max.
mm	20.8	9.5	0.51 0.38	0.25	27.2	2.04 2.54	13.75	2.54	5.08	12.7	8.8	4.15 3.85	2.4	38.1	25.4	10.2	4.2	44.75 44.25	8.2 7.8	6-32 UNC	0.25	0.7	0.1	3.8

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT115J						~~04-02-04~~ 10-06-18

Fig 1. Package outline SOT115J

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7. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGY68 v.5	20100928	Product data sheet	-	BGY68 v.4
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Package outline drawings have been updated to the latest version.			
BGY68 v.4 (9397 750 14738)	20050314	Product data sheet	-	BGY68 v.3
BGY68 v.3 (9397 750 08797)	20011018	Product specification	-	BGY68 v.2
BGY68 v.2 (9397 750 02146)	19970414	Product specification	-	BGY68 v.1

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8. Legal information

8.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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